

R8C/LA8A Group

Timer RJ in Pulse Period Measurement Mode

R01AN0078EJ0100 Rev.1.00 Apr. 25, 2011

1. Abstract

This document describes a setting method and an application example for the R8C/LA8A Group using timer RJ in pulse period measurement mode.

2. Introduction

The application example described in this document applies to the following microcomputer (MCU) and parameter:

- MCU: R8C/LA8A Group
- XIN clock frequency: 20 MHz

This application note can be used with other R8C Family MCUs which have the same special function registers (SFRs) as the above group. Check the manual for any modifications to functions. Careful evaluation is recommended before using the program described in this application note.



3. Application Example

3.1 Program Outline

The pulse period of the external signal input to the TRJ0IO pin is measured.

Settings

- Use timer RJ0.
- Use pulse period measurement mode.
- Select f1 as the count source of timer RJ0.
- Select one edge to the TRJ0IO input polarity.
- Measure a period from one rising edge to the next rising edge of the measurement pulse.
- Use the active edge judgment flag.
- Use the timer RJ0 underflow flag.
- Use the P6_2/TRJ0IO pin as the input pin.
- Use the timer RJ0 interrupt.
- Do not use the TRJ0IO input filter.

Figure 3.1 shows a Block Diagram and Figure 3.2 shows a Timing Diagram. Table 3.1 lists the Pin Used and Its Function.

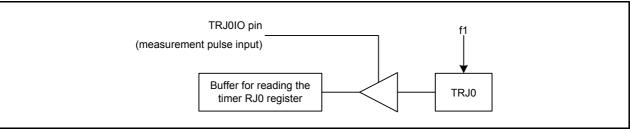


Figure 3.1 Block Diagram



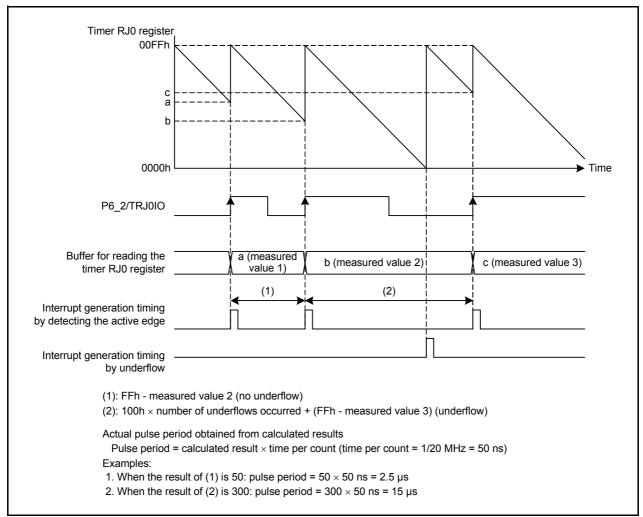


Figure 3.2 Timing Diagram

Table 3.1 Pin Used and Its Function

Pin Name	I/O	Function
P6_2/TRJ0IO	Input	Measurement pulse input

3.2 Memory

Table 3.2Memory

Memory	Size	Remarks
ROM	335 bytes	In the r01an0078_src.c module
RAM	6 bytes	In the r01an0078_src.c module
Maximum user stack	10 bytes	
Maximum interrupt stack	19 bytes	

Memory size varies depending on the C compiler version and compile options.

The above applies to the following conditions:

C compiler: M16C Series, R8C Family C Compiler V.5.45 Release 01

Compile options: -c -finfo -dir "\$(CONFIGDIR)" -R8C



4. Software

This section shows the initial setting procedures and values to set the example described in section **3. Application Example**. Refer to the latest **R8C/LA8A Group** hardware user's manual for details on individual registers. The \times in the register's Setting Value represents bits not used in this application, blank spaces represent bits that do not change, and the dash represents reserved bits or bits that have nothing assigned.

4.1 Function Tables

Declaration	void main (void)	void main (void)								
Outline	Main function	Nain function								
Argument	Argument name		Meaning							
	None		—							
Variable (global)	Variable name		Contents							
valiable (global)	None		—							
Returned value	Туре	Value	Meaning							
	None	—	—							
Function	After initializing the pulse period.	After initializing the system clock and timer RJ0, call the calculation processing of the pulse period.								

Declaration	void mcu_init (void	<i>v</i> oid mcu_init (void)								
Outline	System clock settir	System clock setting								
Argument	Argument name		Meaning							
	None		—							
Variable (global)	Variable name		Contents							
variable (global)	None		—							
Returned value	Туре	Value	Meaning							
	None —		—							
Function	Set the system clock (XIN clock).									

Declaration	void timer_rj_init (vo	void timer_rj_init (void)								
Outline	Initial setting of time	nitial setting of timer RJ associated SFRs								
Argument	Argument name		Meaning							
	None		—							
Variable (global)	Variable name		Contents							
vanable (global)	None		<u> </u>							
Returned value	Туре	Value	Meaning							
	None	—	—							
Function	Initialize SFRs to us	e timer RJ0 in pulse per	iod measurement mode.							



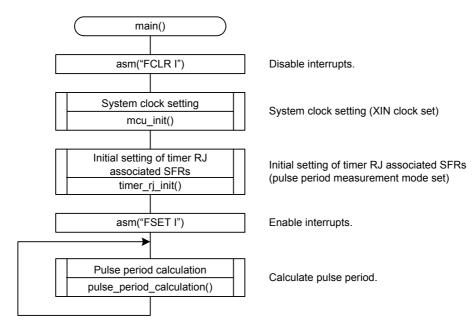
Declaration	void pulse_period_c	alculation (void)						
Outline	Pulse period calcula	Pulse period calculation						
Argument	Argument name		Meaning					
Aigument	None		—					
	Variable name		Contents					
	unsigned char f_edg	ge	Active edge flag					
Variable (global)	unsigned char undf	_cnt	Underflow count					
	unsigned short pres	ent_value	Timer RJ0 register obtained value					
	unsigned short mea	surement_value	Measured value					
Returned value	Туре	Value	Meaning					
	None	—	—					
Function	Calculate the pulse period based on the measured value in pulse period measurement mode.							

Declaration	void _timer_rj_ch0 (void)						
Outline	Timer RJ0 interrupt	Timer RJ0 interrupt handling						
Argument	Argument name		Meaning					
Argument	None		—					
	Variable name		Contents					
Variable (global)	unsigned char f_edg	ge	Active edge flag					
variable (global)	unsigned char undf	_cnt	Underflow count					
	unsigned short pres	ent_value	Timer RJ0 register obtained value					
Returned value	Туре	Value	Meaning					
	None	—	—					
Function	Perform timer RJ0 interrupt handling. When an active edge is received, read TRJ0 register value. When timer RJ underflows, count the number of underflow When the active edge is received and timer RJ underflows, set the obtained v 0000h regardless of the RJ0 register value.							



4.2 Main Function

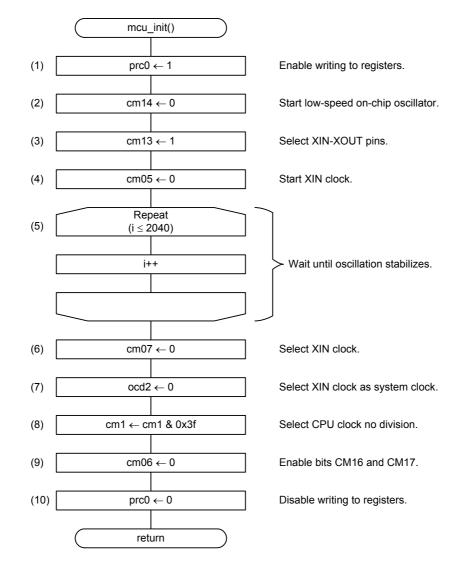
• Flowchart





4.3 System Clock Setting

• Flowchart



• Register settings

(1) Enable writing to registers CM0, CM1, CM3, OCD, FRA0, FRC0, FRA2, and FRC1.

Protect Register (PRCR)												
	Bit	b7	b6	b5	b4	b3	b2	b1	b0			
Setting Value		—	_	—		Х	х	х	1			
Bit	Symbol			Bit Name			Function					
b0	PRC0	Protec	ct bit 0			OCD,	Enables writing to registers CM0, CM1, CM3, OCD, FRA0, FRC0, FRA2, and FRC1 1: Write enabled					

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(2) Start the low-speed on-chip oscillator.

Systen	n Cloc	k Co	ntrol	Register	1 (CM1)								
	Bit	b7	,	b6	b5	b4	b	3	b2	b1	b0		
Setting V	Value				_	0			х	Х	Х]	
	_							1					
Bit	Syn	nbol			Bit Name			Function					R/W
b4	04 CM14 Low-speed on-chip oscillator oscillation stop bit							0: Low-speed on-chip oscillator on					R/W

(3) Select the XIN-XOUT pins.

Systen	System Clock Control Register 1 (CM1)											
	Bit	b7	b6	b5	b4	b3	b2	b1	b0			
Setting	Value					1	х	х	х			
											R/W	
Bit	Symbol			Bit Name			Function					
b3	CM13	Port/XI	IN-XOUT s	switch bit		1: XI	1: XIN-XOUT pins					
						÷						

(4) Oscillate the XIN clock.

Systen	n Clock C	Control I	Register	0 (CM0)								
	Bit	b7	b6	b5	b4	b3	3	b2	b1	b0		
Setting Value				0	х	Х		х	х	—		
Bit Symbol Bit Name								Function				
b5	CM05	XIN clock (XIN-XOUT) stop bit						0: XIN clock oscillates				

- (5) Wait until oscillation stabilizes.
- (6) Select the XIN clock.

System Clock Control Register 0 (CM0)

	Bit	b7		b6	b5	b4	b3	b2	b1	b0		
Setting V	Value	0				х	х	х	х			
											-	
Bit	Syml	bol		E	Bit Name				R/W			
b7	CMC)7	System	clock s	select bit		0: XIN clock or on-chip oscillator clock					R/W



(7) Select the XIN clock as the system clock.

Oscilla	tion S	top I	Detec	tion Regi	ster (OCD)							
	Bit	b	07	b6	b5	b4	b3		b2	b1	b0		
Setting	Value	_					Х		0	х	х]	
-													
Bit	Symb	loc			Bit Name					Functio	on		R/W
b2	OCE)2	On-ch	ip oscillato	or clock sel	ect bit	0:	XIN	clock se	lected			R/W

(8) Set CPU clock division select bit 1.

Syster	n Clock	Control	Register	1 (CM1)						
	Bit	b7	b6	b5	b4	b3	b2	b1	b0	
Setting	Value	0	0				Х	х	х	
Bit	Symbo	I		Bit Name				Functio	on	R/W
b6	CM16	CPU	lock divisio	on select bi	+ 1	b7 b6				R/W
b7	CM17					0 0: 1	No division	mode		R/W

(9) Set CPU clock division select bit 0.

System	n Clock C	Control	Register	0 (CM0)							
	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting \	Value		0		Х	х	Х	х	—		
Bit	Symbol		E	Bit Name				Functio	n		R/W
b6	CM06	CPU cl	ock divisio	on select bit	: 0	0: Bits	CM16 and	CM17 in 0	CM1 registe	er enabled	R/W

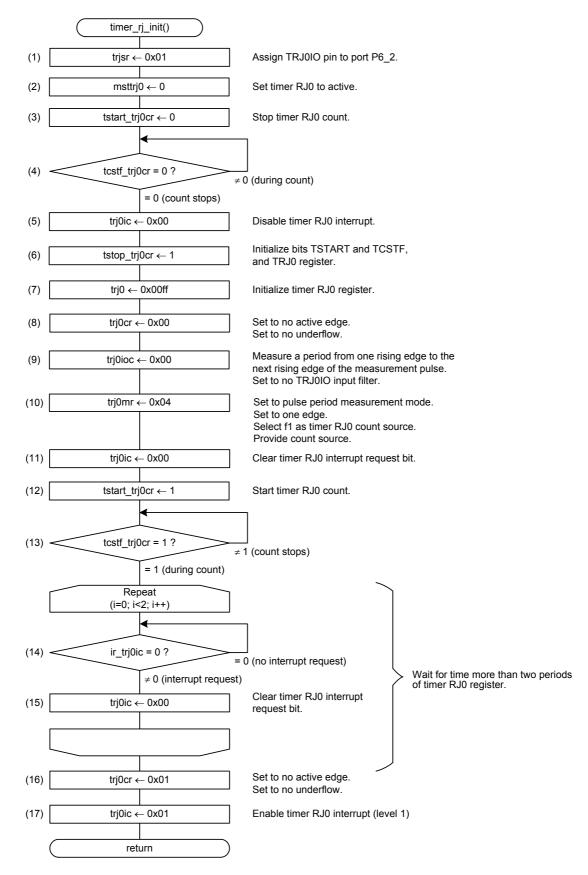
(10)Disable writing to registers CM0, CM1, CM3, OCD, FRA0, FRC0, FRA2, and FRC1.

Protect	t Registe	r (PRC	R)								
	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting V	Value	—	—			х	Х	х	0]	
Bit	Symbol		Bit Nar	ne			Fur	nction			R/W
b0	PRC0	Protec	t bit 0			RA2, and F		M0, CM1,	CM3, OCD	, FRA0,	R/W



4.4 Initial Setting of Timer RJ Associated SFRs

• Flowchart





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- Register settings
- (1) Set the timer RJ pin select register.

Timer RJ Pin Select Register (TRJSR)

	Bit	b7	b6	b5	b4		b3	b2	b1	b0	
Setting	Value	—	—	х	Х		—	_	0	1	
Bit	Sy	/mbol	E	Bit Name					Function		R/W
b0	TRJC	IOSEL0	TRJ0IO pii	n select hit		b1 b					R/W
b1	TRJC	IOSEL1				0 1	: P6_2 ass	signed			R/W

(2) Set timer RJ0 to active.

Module Standby Control Register 1 (MSTCR1)

	Bit I	o7	b6	b5	b4	b3	b2	b1	b0		
Setting '	Value	_		х	х	0	х	х	х		
										-	
Bit	Symbol		Bit Na	ame			Fu	nction			R/W
b3	MSTTRJC	Time	r RJ0 stan	dby bit	0: Activ	е					R/W

(3) Stop the timer RJ0 count.

Timer RJ0 Control Register (TRJ0CR)

	Bit	b7	b6	b5	b4	b3	b2	b1	b0	
Setting '	Value	—							0	
Bit	Symbol		Bit I	Name				Function		R/W
b0	TSTART	Timer	RJ0 count	t start bit		0: Count stop	DS			R/W

(4) Wait until the timer RJ0 count stops.

Timer RJ0 Control Register (TRJ0CR)

Bit	Symbol	Bit Name	Function	R/W
b1	TCSTF	Limer R.IO count status flag	0: Count stops 1: During count operation	R



(5) Disable the timer RJ0 interrupt.

Interru	pt Contro	ol Re	egister (TRJ	JIC)							
	Bit	b7	b6	b5	b	4	b3	b2	b1	b0	
Setting \	√alue	—	—	—	_	-	0	0	0	0	
Bit	Symbo	ol	Bit N	lame				F	unction		R/W
b0	ILVL0										R/W
b1	ILVL1	Int	terrupt priority	/ level sele	ct bit	b2 b1 b 0 0	0: Level 0	(interrupt d	lisabled)		R/W
b2	ILVL2										R/W
b3	IR	Int	terrupt reques	st bit		0: No	o interrupt	requested			R/W

(6) Initialize bits TSTART and TCSTF, and the TRJ0 register.

Timer RJ0 Control Register (TRJ0CR)

	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting	Value	—				—	1				
Bit	Symbo	I	Bit	Name				Function			R/W
b2	TSTOF	Timer	RJ0 count	forcible st		When this t When read,			t is forcibly	stopped.	R/W

(7) Initialize the timer RJ0 register to 00FFh.

Timer RJ0 Register (TRJ0)

Bit	b7	b6	b5	b4	b3	b2	b1	b0
Setting Value	1	1	1	1	1	1	1	1
Bit	b15	b14	b13	b12	b11	b10	b9	b8
Setting Value	0	0	0	0	0	0	0	0

Bit	Mode	Function	Setting Range	R/W
b15-b0		Measures the pulse period of input pulses from external (counts an internal count source).	0001h to FFFFh	R/W

(8) Set the timer RJ0 control register.

Timer RJ0 Control Register (TRJ0CR)

Bit b5 b7 b6 b4 b3 b2 b1 b0 Setting Value 0 _ 0 — —

Bit	Symbol	Bit Name	Function	R/W
b4	TEDGF	Active edge judgment flag	0: Active edge not received	R/W
b5	TUNDF	Timer RJ0 underflow flag	0: No underflow	R/W



(9) Set the timer RJ0 I/O control register.

Bit b7 b6 b5 b4 b3 b2 b1 b0 Setting Value 0 0 0 0 — 0 0 0 Bit Symbol Bit Name Function R/M b0 TEDGSEL TRJ0IO polarity switch bit 0: Period from one rising edge to next rising edge of measured pulse is measured R/M										• • • •								
Bit Symbol Bit Name Function R/V b0 TEDGSEL TR I0IO polarity switch bit 0: Period from one rising edge to next rising edge of R/V					b0	b1	b2	b3	b4		b5	b6		b7	Bit			
b0 TEDGSEL TR IOLO polarity switch bit 0: Period from one rising edge to next rising edge of RA					0	0	0	_	0		0	0		0	Value	Setting		
b0 TEDGSEL TR I010 polarity switch bit 0: Period from one rising edge to next rising edge of RA															-			
	W	R				Function					it Name	В		nbol	Syn	Bit		
	W	R	edge of								ity switch	J0IO polar	TR	GSEL	TEDO	b0		
b1 TOPCR TRJ0IO output control bit	W	R		Set to 0 in pulse period measurement mode							ut control	TOF	b1					
b2 TOENA TRJ0O output enable bit Set to 0 in pulse period measurement mode.	W	R		- Set to o in puise period measurement mode.							t enable	J0O outpu	TR	ENA	TOE	b2		
b4 TIPF0 TRIOLO input filter select bit	W	R						5 b4	it I	ot k	filtor cold		тр	PF0	TIF	b4		
b5 TIPF1 0 0: No filter R/	W	R		0 0: No filter						RJ0IO input filter select bit					TIF	b5		
b6 TIOGT0 TRJ0IO event input control bit Set to 0 in pulse period measurement mode.	W	R/		odo	mont m	d moasuro	ulso porio	Set to 0 in r	Lbit	b6 TIOGT0 TRJ0IO event input control bi						b6		
b7 TIOGT1 RADIO event input control bit Set to 0 in pulse period measurement mode.	W	R/		oue.			uise perior			b7 TIOGT1								

Timer RJ0 I/O Control Register (TRJ0IOC)

(10) Set the timer RJ0 mode register.

Timer RJ0 Mode Register (TRJ0MR)

Bit	b7	b6	b5	b4	b3	b2	b1	b0	
Setting Value	0	0	0	0	0	1	0	0	

Bit	Symbol	Bit Name	Function	R/W
b0	TMOD0			R/W
b1	TMOD1	Timer RJ0 operating mode select bit	1 0 0: Pulse period measurement mode	R/W
b2	TMOD2			R/W
b3	TEDGPL	TRJ0IO input polarity select bit	0: One edge	R/W
b4	TCK0			R/W
b5	TCK1	Timer RJ0 count source select bit	b6 b5 b4 0 0 0: f1	R/W
b6	TCK2			R/W
b7	TCKCUT	Timer RJ0 count source cut off bit	0: Count source provided	R/W

(11)Set to no timer RJ0 interrupt request.

Interrupt Control Register (TRJ0IC)

Bit	b7	b6	b5	b4	b3	b2	b1	b0	
Setting Value	_	—	—	—	0]
Bit Syn	nbol	Bit	Name				Function		R/W

Bit	Symbol	Bit Name	Function	R/W
b3	IR	Interrupt request bit	0: No interrupt requested	R/W

(12) Start the timer RJ0 count.

Timer I	RJ0 Cor	trol Re	egister (TF	RJ0CR)								
	Bit	b7	b6	b5	b4		b3	bź	2	b1	b0	
Setting V	Value	—	—				_				1	
Bit	Symbol		Bit	Name					F	unction		R/W
b0	TSTAR	Time	r RJ0 count	t start bit		1: C	ount sta	rts				R/W

(13) Wait until the timer RJ0 count starts.

Timer RJ0 Control Register (TRJ0CR)

ſ	Bit	Symbol	Bit Name	Function	R/W
	b1	TCSTF	Limer R.IU count status tiad	0: Count stops 1: During count operation	R

(14)Determine the timer RJ0 interrupt request bit.

Interrupt Control Register (TRJ0IC)

Bit	Symbol	Bit Name	Function	R/W
b3	IR	Interrupt request bit	0: No interrupt requested 1: Interrupt requested	R/W

(15) Set to no timer RJ0 interrupt request.

Interrupt Control Register (TRJ0IC)

	Bit	b7	b6	b5	b4	b3	b2	b1	b0			
Setting	Value			_	_	0]		
Bit	Symbol		Bit	Name				Function			R/W	
b3	IR	Interru	upt request	t bit		0: No interru	upt reques	ted			R/W	



(16) Set to no active edge and no underflow.

Timer I	RJ0 C	ontr	ol Re	gister (TR	J0CR)							
	Bit	t	57	b6	b5	b4	b3	b2	b1	b0		
Setting '	Value	-		—	0	0	—]	
Bit	Sym	bol		Bit I	Name				Function			R/W
b4	TED	GF	Active	edge judg	ment flag		0: Active e	edge not rec	eived			R/W
b5	TUN	DF	Timer	RJ0 under	flow flag		0: No und	erflow				R/W

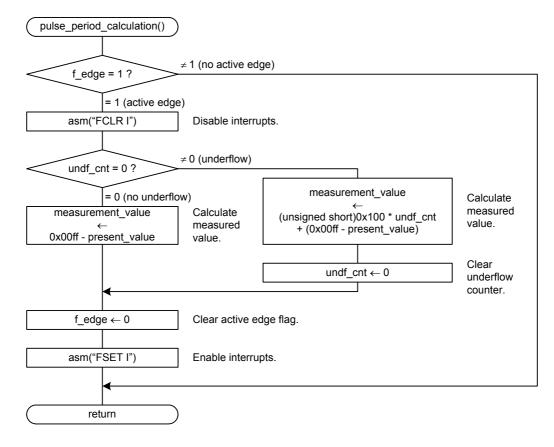
(17) Enable the timer RJ0 interrupt (level 1).

Interrupt Control Register (TRJ0IC)												
	Bit k	07	b6	b5	b	4	b3	b2	b1	b0		
Setting \	Setting Value — — — —						0	0	0	1		
Bit	Symbol		Bit Name					F	unction			R/W
b0	ILVL0		Dit Name						R/W			
b1	ILVL1	Interru	Interrupt priority level select b				³⁰ 1: Level 1					R/W
b2	ILVL2											R/W
b3	b3 IR Interrupt request bit					0: N	o interrupt	requested				R/W



4.5 Pulse Period Calculation

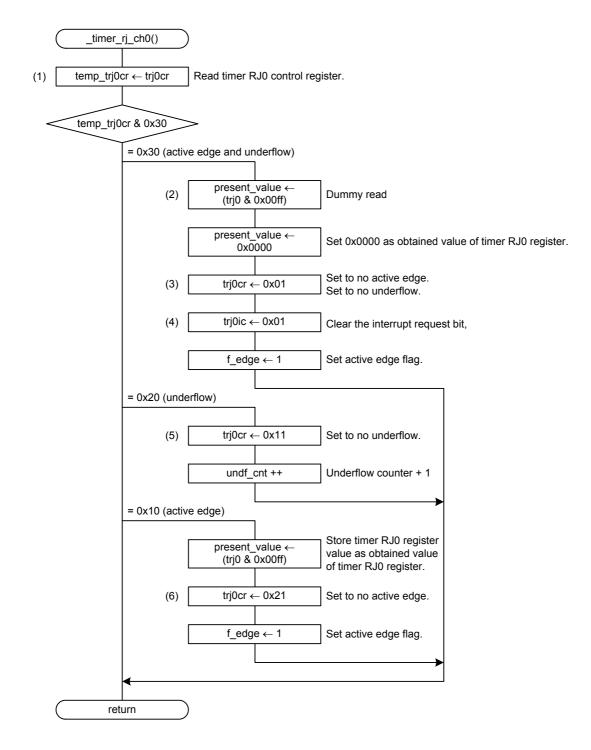
• Flowchart





4.6 Timer RJ0 Interrupt Handling

• Flowchart





• Register settings

(1) Read the timer RJ0 control register to determine the statuses of the active edge and underflow.

Timer RJ0 Control Register (TRJ0CR)

Bit	Symbol	Bit Name	Function	R/W
b4	TEDGF		0: Active edge not received 1: Active edge received (end of measurement period)	R/W
b5	TUNDF	Timer RJ0 underflow flag	0: No underflow 1: Underflow	R/W

(2) Read the timer RJ0 register.

Timer RJ0 Register (TRJ0)

Bit	Mode Function		Setting Range	R/W
b15-b0		Measures the pulse period of input pulses from external (counts an internal count source).	0001h to FFFFh	R/W

(3) Set to no active edge and no underflow.

Bit	b7	b6	b5	b4	b3	b2	b1	b0
Setting Value			0	0	_			

Bit	Symbol	Bit Name	Function	R/W
b4	TEDGF	Active edge judgment flag	0: Active edge not received	R/W
b5	TUNDF	Timer RJ0 underflow flag	0: No underflow	R/W

(4) Set to no timer RJ0 interrupt request. When the underflow occurs immediately after interrupt handling by detecting an active edge is started, or an active edge is detected immediately after interrupt handling that occurs from an underflow, the interrupt request bit becomes 1. When the interrupt handling being executed is completed while the interrupt request bit is 1, interrupt handling is executed again immediately after returning from interrupt handling. Set the interrupt request bit to 0 to not execute this interrupt handling.

Interrupt Control Register (TRJ0IC)

	Bit	b7	b6	b5	b4	b3	b2	b1	b0		
Setting	Value	_	_	—	_	0					
Bit	Symbol		Bit	Name				Function		R/W	I
b3	IR	Interr	upt reques	t bit		0: No interro	upt reques	ted		R/W	



(5) Set to no underflow. When writing 1 to the TEDGF bit, the TEDGF bit value is retained.

Timer I	Timer RJ0 Control Register (TRJ0CR)											
	Bit	t	57	b6	b5	b4	b3	b2	b1	b0		
Setting V	Value	-	_		0		—					
Bit	Symb	bol	Bit Name				Function					R/W
b4	TED	GF	Active edge judgment flag			0: Active edge not received					R/W	



5. Sample Program

A sample program can be downloaded from the Renesas Electronics website. To download, click "Application Notes" in the left-hand side menu of the R8C Family page.

6. Reference Documents

R8C/LA8A Group User's Manual: Hardware Rev.1.01 The latest version can be downloaded from the Renesas Electronics website.

Technical Update/Technical News The latest information can be downloaded from the Renesas Electronics website.

Website and Support

Renesas Electronics website http://www.renesas.com/

Inquiries http://www.renesas.com/inquiry



Revision History	R8C/LA8A Group
i te vision i nistory	Timer RJ in Pulse Period Measurement Mode

Rev.	Date		Description
itev.	Dale	Page	Summary
1.00	Apr. 25, 2011	—	First edition issued

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
- 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 - In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do
 not access these addresses; the correct operation of LSI is not guaranteed if they are
 accessed.
- 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.
- 5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

— The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

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